Precision, 20 MHz, CMOS, Rail-to-Rail Input/Output Operational Amplifiers

AD8615/AD8616/AD8618

FEATURES

Low offset voltage: 65 µV maximum
Single-supply operation: 2.7 V to 5.0 V
Low noise: 8 nV/√Hz
Wide bandwidth: >20 MHz
Slew rate: 12 V/µs
High output current: 150 mA
No phase reversal
Low input bias current: 1 pA
Low supply current: 2 mA
Unity-gain stable

APPLICATIONS

Barcode scanners
Battery-powered instrumentation
Multipole filters
Sensors
ASIC input or output amplifiers
Audio
Photodiode amplification

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GENERAL DESCRIPTION

The AD8615/AD8616/AD8618 are single/dual/quad, rail-to-rail, input and output, single-supply amplifiers featuring very low offset voltage, wide signal bandwidth, and low input voltage and current noise. The parts use a patented trimming technique that achieves superior precision without laser trimming. The AD8615/AD8616/ AD8618 are fully specified to operate from 2.7 V to 5 V single supplies.

The combination of >20 MHz bandwidth, low offset, low noise, and low input bias current makes these amplifiers useful in a wide variety of applications. Filters, integrators, photodiode amplifiers, and high impedance sensors all benefit from the combination of performance features. AC applications benefit from the wide bandwidth and low distortion. The AD8615/AD8616/ AD8618 offer the highest output drive capability of the DigiTrim® family, which is excellent for audio line drivers and other low impedance applications.

Applications for the parts include portable and low powered instrumentation, audio amplification for portable devices, portable phone headsets, bar code scanners, and multipole filters. The ability to swing rail-to-rail at both the input and output enables designers to buffer CMOS ADCs, DACs, ASICs, and other wide output swing devices in single-supply systems.

PIN CONFIGURATIONS

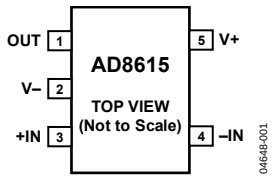

Figure 1. 5-Lead TSOT-23 (UJ-5)

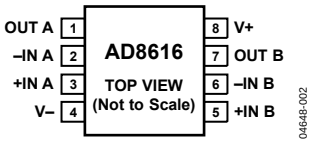

Figure 2. 8-Lead MSOP (RM-8)

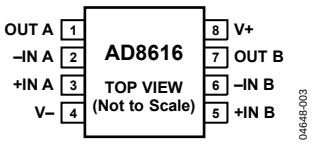

Figure 3. 8-Lead SOIC (R-8)

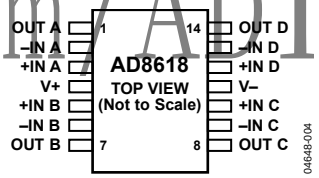

Figure 4. 14-Lead TSSOP (RU-14)

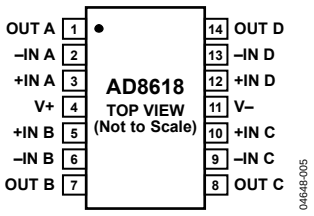

Figure 5. 14-Lead SOIC (R-14)

The AD8615/AD8616/AD8618 are specified over the extended industrial temperature range (−40°C to +125°C). The AD8615 is available in 5-lead TSOT-23 package. The AD8616 is available in 8-lead MSOP and narrow SOIC surface-mount packages; the MSOP version is available in tape and reel only. The AD8618 is available in 14-lead SOIC and TSSOP packages.

Rev. E
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5/08—Rev. C to Rev. D

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1/05—Rev. A to Rev. B

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4/04—Rev. 0 to Rev. A

Added AD8618 ... Universal
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1/04—Revision 0: Initial Version

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SPECIFICATIONS

V_S =5 V, V_{CM} = V_S/2, T_A = 25°C, unless otherwise noted.

Table 1.

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
INPUT CHARACTERISTICS						
Offset Voltage, AD8616/AD8618	V_{OS}	V_S = 3.5 V at V_{CM} = 0.5 V and 3.0 V		23	60	µV
Offset Voltage, AD8615				23	100	µV
		V_{CM} = 0 V to 5 V		80	500	µV
		−40°C < T_A < +125°C			800	µV
Offset Voltage Drift, AD8616/AD8618	$\Delta V_{OS}/\Delta T$	−40°C < T_A < +125°C		1.5	7	µV/°C
Offset Voltage Drift, AD8615				3	10	µV/°C
Input Bias Current	I_B			0.2	1	pA
		−40°C < T_A < +85°C			50	pA
		−40°C < T_A < +125°C			550	pA
Input Offset Current	I_{OS}			0.1	0.5	pA
		−40°C < T_A < +85°C			50	pA
		−40°C < T_A < +125°C			250	pA
Input Voltage Range			0		5	V
Common-Mode Rejection Ratio	CMRR	V_{CM} = 0 V to 4.5 V	80	100		dB
Large Signal Voltage Gain	A_{VO}	R_L = 2 kΩ, V_O = 0.5 V to 5 V	105	1500		V/mV
Input Capacitance	C_{DIFF}			2.5		pF
	C_{CM}			6.7		pF
OUTPUT CHARACTERISTICS						
Output Voltage High	V_{OH}	I_L = 1 mA	4.98	4.99		V
		I_L = 10 mA	4.88	4.92		V
		−40°C < T_A < +125°C	4.7			V
Output Voltage Low	V_{OL}	I_L = 1 mA		7.5	15	mV
		I_L = 10 mA		70	100	mV
		−40°C < T_A < +125°C			200	mV
Output Current	I_{OUT}			±150		mA
Closed-Loop Output Impedance	Z_{OUT}	f = 1 MHz, A_V = 1		3		Ω
POWER SUPPLY						
Power Supply Rejection Ratio	PSRR	V_S = 2.7 V to 5.5 V	70	90		dB
Supply Current per Amplifier	I_{SY}	V_O = 0 V		1.7	2	mA
		−40°C < T_A < +125°C			2.5	mA
DYNAMIC PERFORMANCE						
Slew Rate	SR	R_L = 2 kΩ		12		V/µs
Settling Time	t_S	To 0.01%		<0.5		µs
Gain Bandwidth Product	GBP			24		MHz
Phase Margin	$Ø_m$			63		Degrees
NOISE PERFORMANCE						
Peak-to-Peak Noise	e_n p-p	0.1 Hz to 10 Hz		2.4		µV
Voltage Noise Density	e_n	f = 1 kHz		10		nV/√Hz
		f = 10 kHz		7		nV/√Hz
Current Noise Density	i_n	f = 1 kHz		0.05		pA/√Hz
Channel Separation	C_S	f = 10 kHz		−115		dB
		f = 100 kHz		−110		dB

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V_S = 2.7 V, V_{CM} = V_S/2, T_A = 25°C, unless otherwise noted.

Table 2.

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
INPUT CHARACTERISTICS						
Offset Voltage, AD8616/AD8618	V_{OS}	V_S = 3.5 V at V_{CM} = 0.5 V and 3.0 V		23	65	µV
Offset Voltage, AD8615				23	100	µV
		V_{CM} = 0 V to 2.7 V		80	500	µV
		−40°C < T_A < +125°C			800	µV
Offset Voltage Drift, AD8616/AD8618	$\Delta V_{OS}/\Delta T$	−40°C < T_A < +125°C		1.5	7	µV/°C
Offset Voltage Drift, AD8615				3	10	µV/°C
Input Bias Current	I_B			0.2	1	pA
		−40°C < T_A < +85°C			50	pA
		−40°C < T_A < +125°C			550	pA
Input Offset Current	I_{OS}			0.1	0.5	pA
		−40°C < T_A < +85°C			50	pA
		−40°C < T_A < +125°C			250	pA
Input Voltage Range			0		2.7	V
Common-Mode Rejection Ratio	CMRR	V_{CM} = 0 V to 2.7 V	80	100		dB
Large Signal Voltage Gain	A_{VO}	R_L = 2 kΩ, V_O = 0.5 V to 2.2 V	55	150		V/mV
Input Capacitance	C_{DIFF}			2.5		pF
	C_{CM}			7.8		pF
OUTPUT CHARACTERISTICS						
Output Voltage High	V_{OH}	I_L = 1 mA	2.65	2.68		V
		−40°C < T_A < +125°C	2.6			V
Output Voltage Low	V_{OL}	I_L = 1 mA		11	25	mV
		−40°C < T_A < +125°C			30	mV
Output Current	I_{OUT}			±50		mA
Closed-Loop Output Impedance	Z_{OUT}	f = 1 MHz, A_V = 1		3		Ω
POWER SUPPLY						
Power Supply Rejection Ratio	PSRR	V_S = 2.7 V to 5.5 V	70	90		dB
Supply Current per Amplifier	I_{SY}	V_O = 0 V		1.7	2	mA
		−40°C < T_A < +125°C			2.5	mA
DYNAMIC PERFORMANCE						
Slew Rate	SR	R_L = 2 kΩ		12		V/µs
Settling Time	t_S	To 0.01%		<0.3		µs
Gain Bandwidth Product	GBP			23		MHz
Phase Margin	$Ø_m$			42		Degrees
NOISE PERFORMANCE						
Peak-to-Peak Noise	e_n p-p	0.1 Hz to 10 Hz		2.1		µV
Voltage Noise Density	e_n	f = 1 kHz		10		nV/√Hz
		f = 10 kHz		7		nV/√Hz
Current Noise Density	i_n	f = 1 kHz		0.05		pA/√Hz
Channel Separation	C_S	f = 10 kHz		−115		dB
		f = 100 kHz		−110		dB

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ABSOLUTE MAXIMUM RATINGS

Table 3.

Parameter	Rating
Supply Voltage	6 V
Input Voltage	GND to V_S
Differential Input Voltage	±3 V
Output Short-Circuit Duration to GND	Indefinite
Storage Temperature Range	−65°C to +150°C
Operating Temperature Range	−40°C to +125°C
Lead Temperature (Soldering, 60 sec)	300°C
Junction Temperature	150°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

θ_{JA} is specified for the worst-case conditions, that is, θ_{JA} is specified for a device soldered in a circuit board for surface-mount packages.

Table 4.

Package Type	θ_{JA}	θ_{JC}	Unit
5-Lead TSOT-23 (UJ)	207	61	°C/W
8-Lead MSOP (RM)	210	45	°C/W
8-Lead SOIC (R)	158	43	°C/W
14-Lead SOIC (R)	120	36	°C/W
14-Lead TSSOP (RU)	180	35	°C/W

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

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TYPICAL PERFORMANCE CHARACTERISTICS

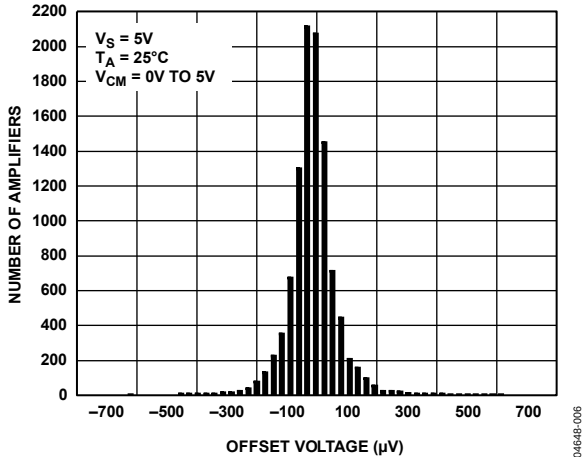

Figure 6. Input Offset Voltage Distribution

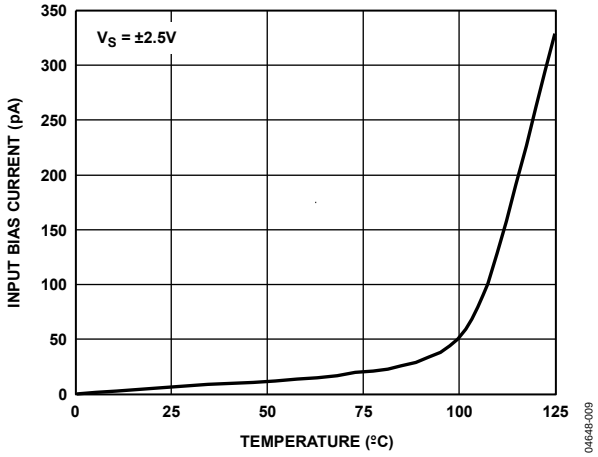

Figure 9. Input Bias Current vs. Temperature

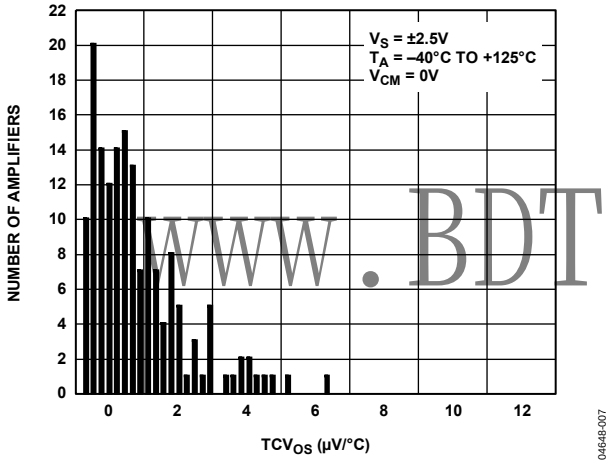

Figure 7. Offset Voltage Drift Distribution

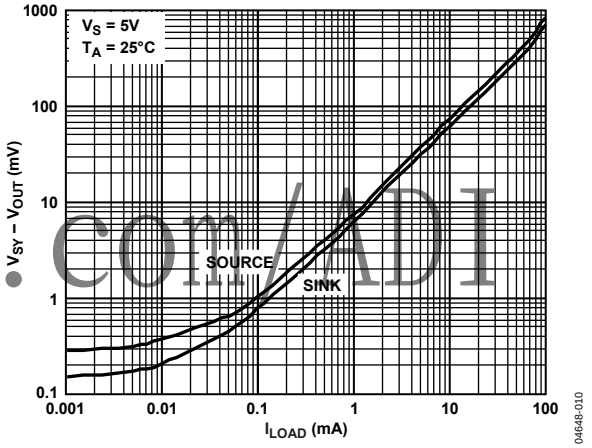

Figure 10. Output Voltage to Supply Rail vs. Load Current

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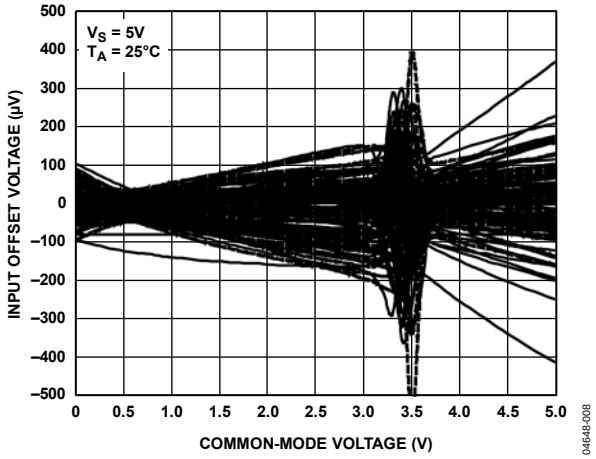

Figure 8. Input Offset Voltage vs. Common-Mode Voltage (200 Units, Five Wafer Lots Including Process Skews)

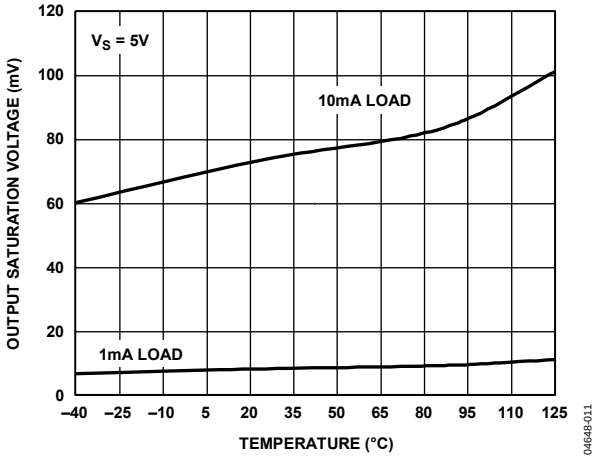

Figure 11. Output Saturation Voltage vs. Temperature

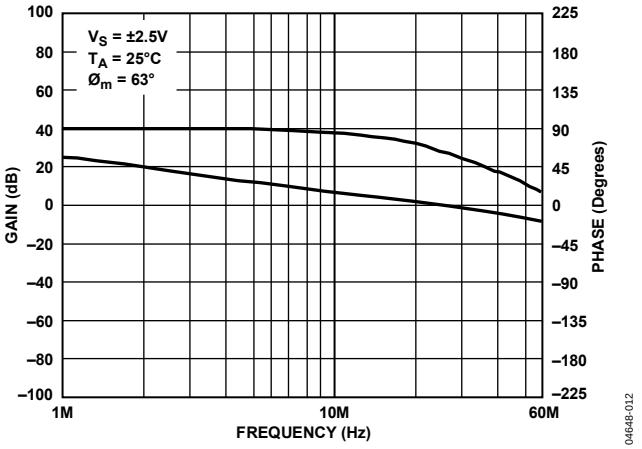

Figure 12. Open-Loop Gain and Phase vs. Frequency

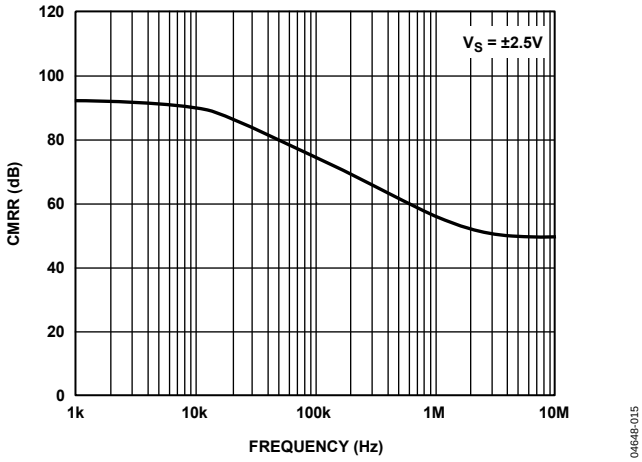

Figure 15. CMRR vs. Frequency

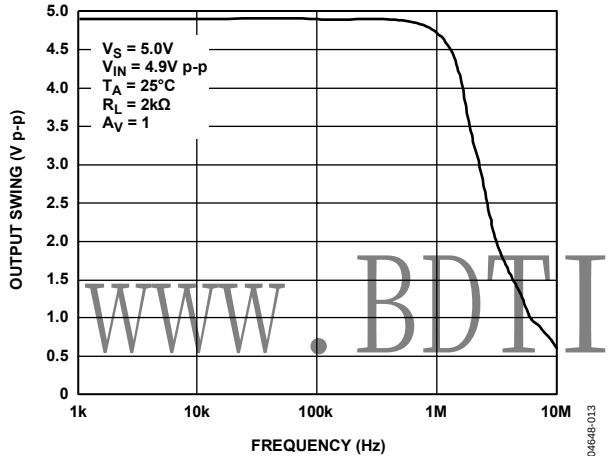

Figure 13. Closed-Loop Output Voltage Swing vs. Frequency

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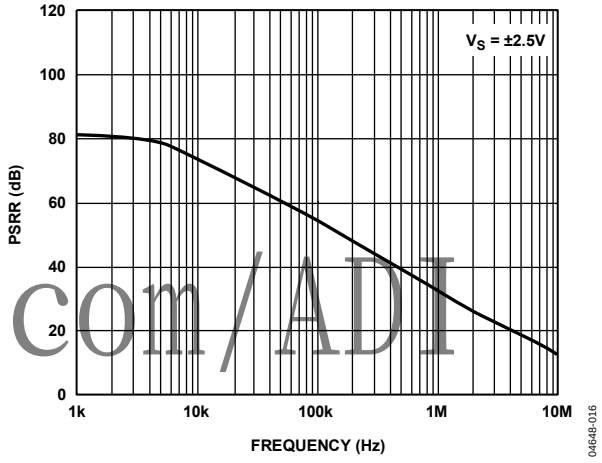

Figure 16. PSRR vs. Frequency

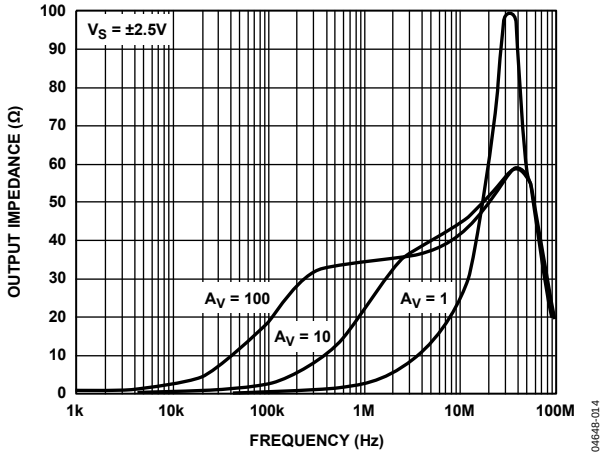

Figure 14. Output Impedance vs. Frequency

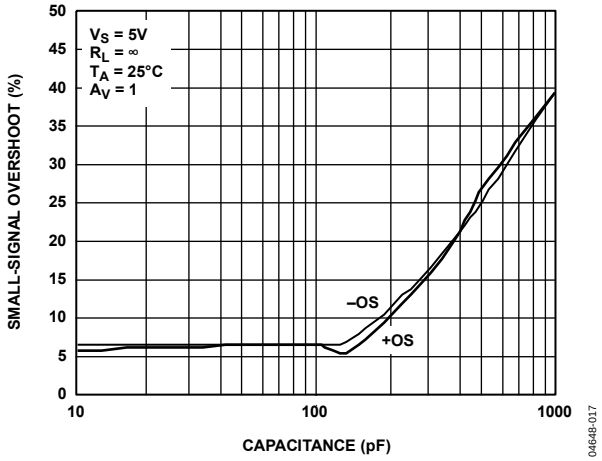

Figure 17. Small-Signal Overshoot vs. Load Capacitance

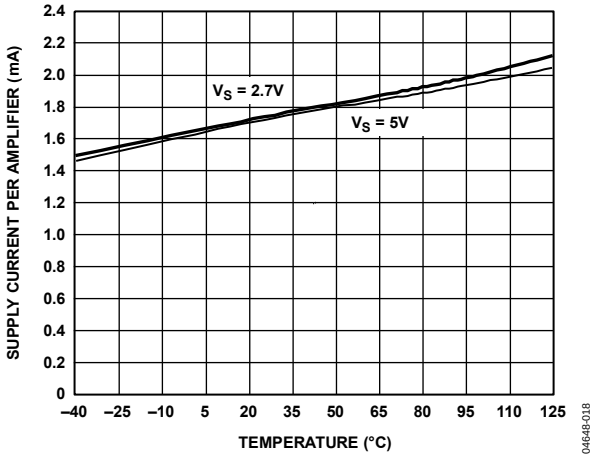

Figure 18. Supply Current vs. Temperature

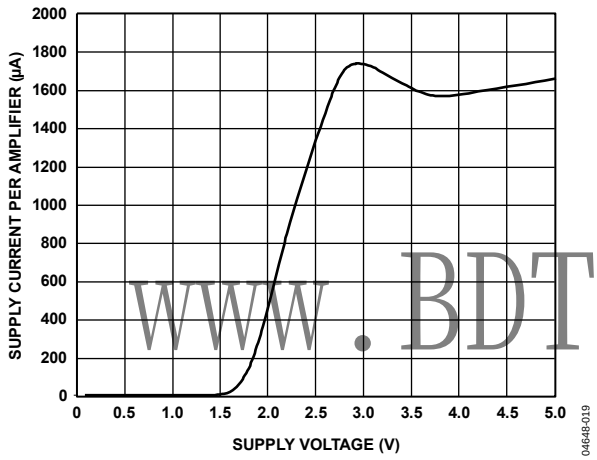

Figure 19. Supply Current per Amplifier vs. Supply Voltage

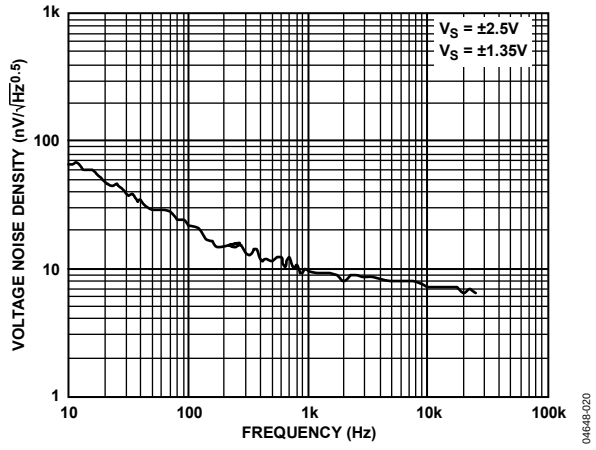

Figure 20. Voltage Noise Density vs. Frequency

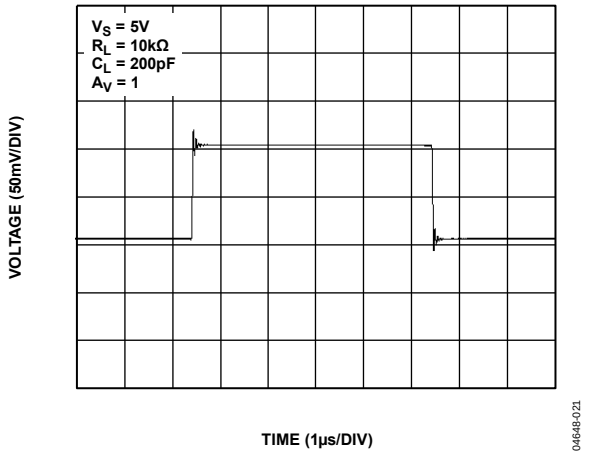

Figure 21. Small Signal Transient Response

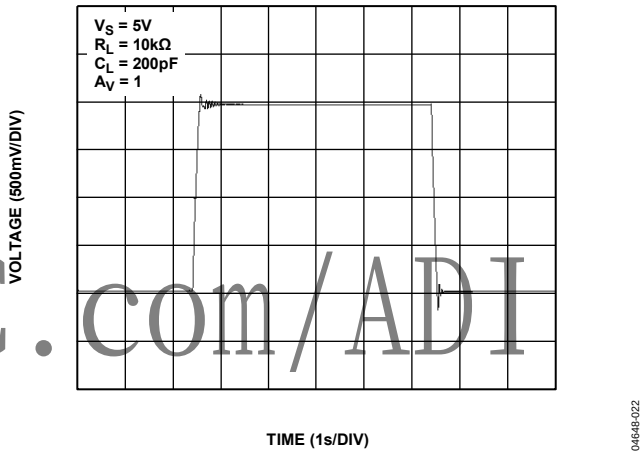

Figure 22. Large Signal Transient Response

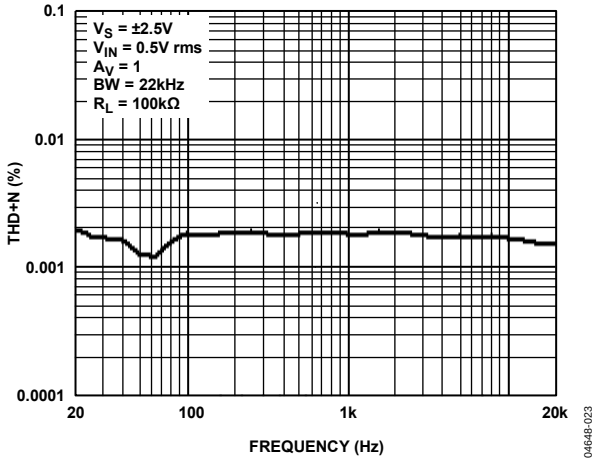

Figure 23. THD + N vs. Frequency

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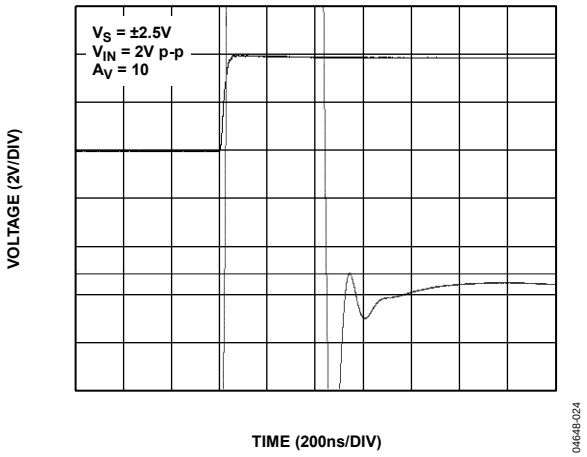

Figure 24. Settling Time

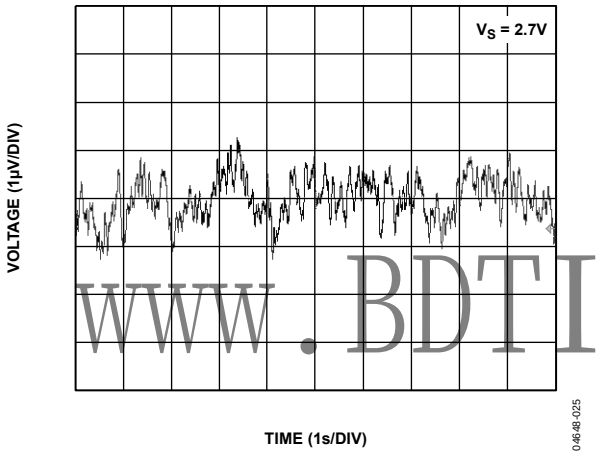

Figure 25. 0.1 Hz to 10 Hz Input Voltage Noise

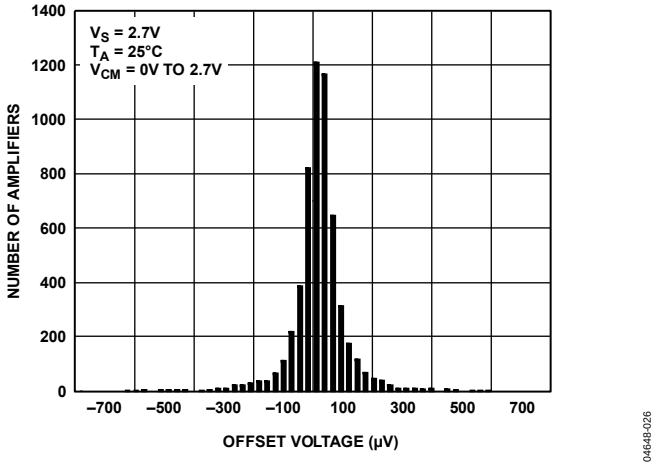

Figure 26. Input Offset Voltage Distribution

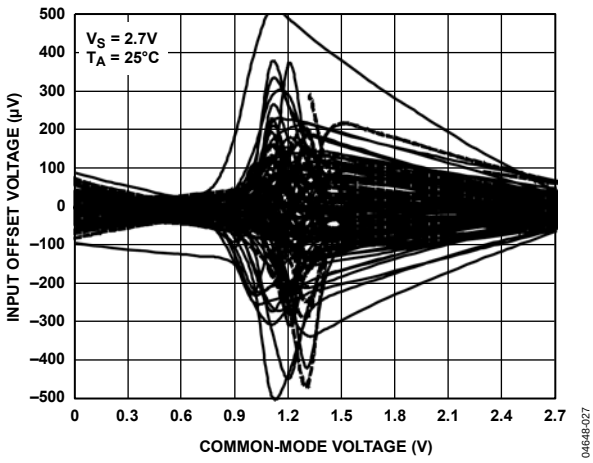

Figure 27. Input Offset Voltage vs. Common-Mode Voltage (200 Units, Five Wafer Lots Including Process Skews)

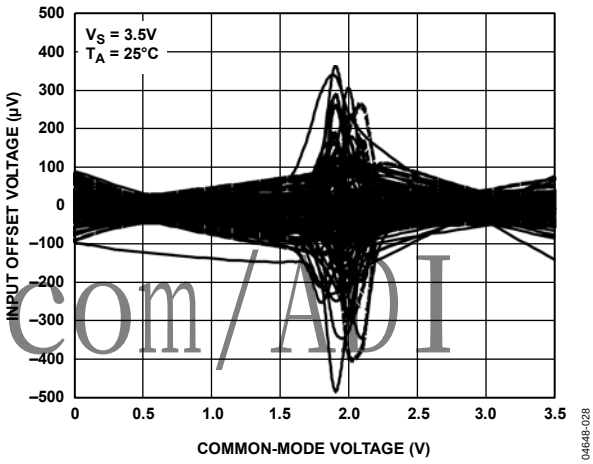

Figure 28. Input Offset Voltage vs. Common-Mode Voltage (200 Units, Five Wafer Lots Including Process Skews)

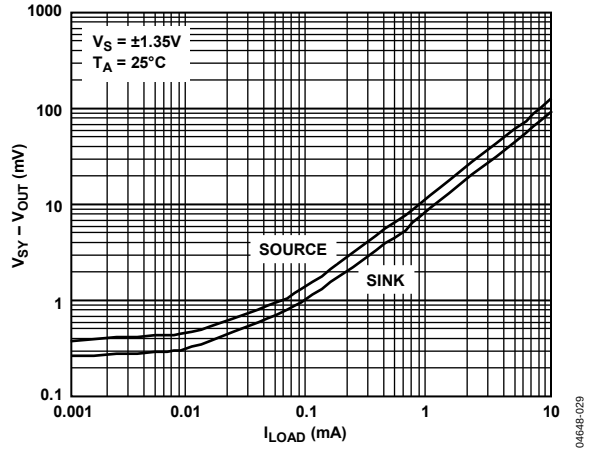

Figure 29. Output Voltage to Supply Rail vs. Load Current

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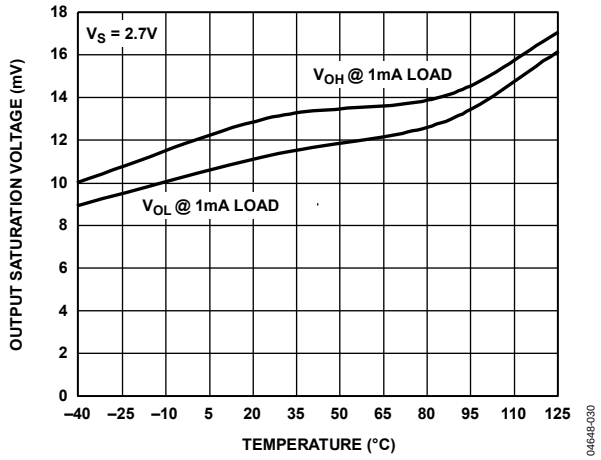

Figure 30. Output Saturation Voltage vs. Temperature

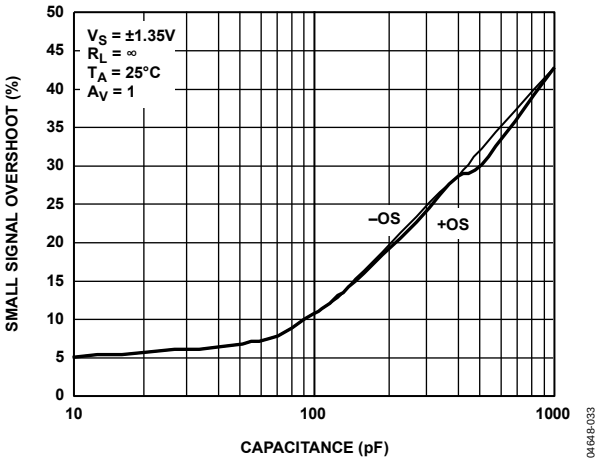

Figure 33. Small Signal Overshoot vs. Load Capacitance

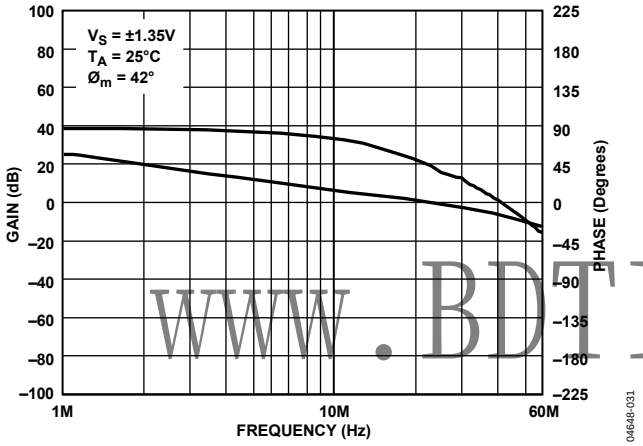

Figure 31. Open-Loop Gain and Phase vs. Frequency

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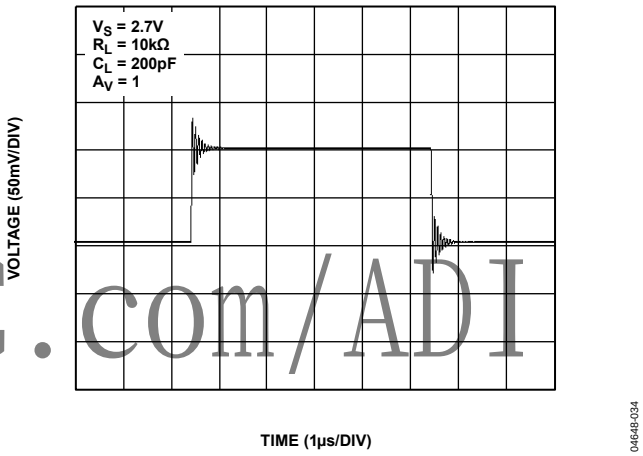

Figure 34. Small Signal Transient Response

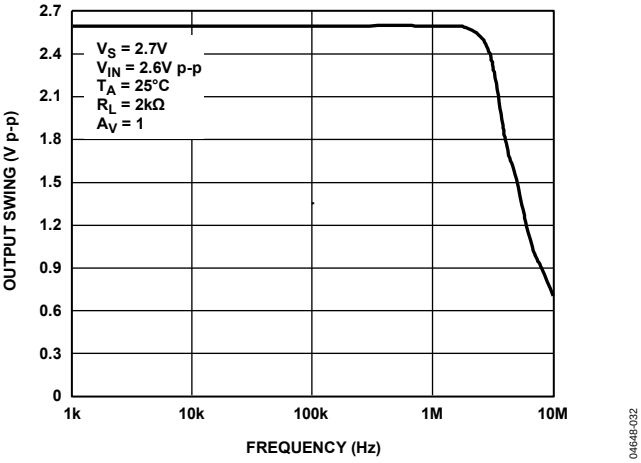

Figure 32. Closed-Loop Output Voltage Swing vs. Frequency

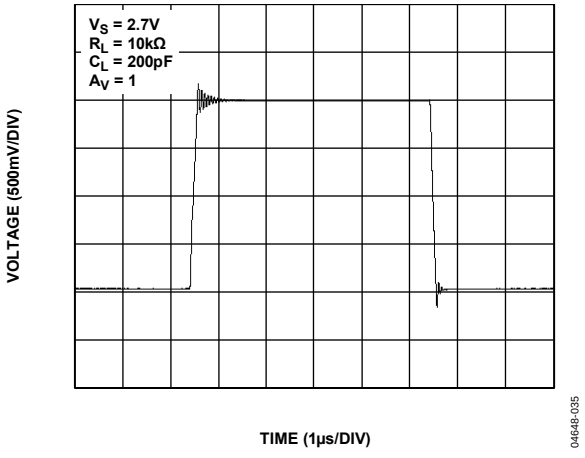

Figure 35. Large Signal Transient Response

APPLICATIONS INFORMATION

INPUT OVERVOLTAGE PROTECTION

The AD8615/AD8616/AD8618 have internal protective circuitry that allows voltages exceeding the supply to be applied at the input.

It is recommended, however, not to apply voltages that exceed the supplies by more than 1.5 V at either input of the amplifier. If a higher input voltage is applied, series resistors should be used to limit the current flowing into the inputs.

The input current should be limited to <5 mA. The extremely low input bias current allows the use of larger resistors, which allows the user to apply higher voltages at the inputs. The use of these resistors adds thermal noise, which contributes to the overall output voltage noise of the amplifier.

For example, a 10 kΩ resistor has less than 13 nV/√Hz of thermal noise and less than 10 nV of error voltage at room temperature.

OUTPUT PHASE REVERSAL

The AD8615/AD8616/AD8618 are immune to phase inversion, a phenomenon that occurs when the voltage applied at the input of the amplifier exceeds the maximum input common mode.

Phase reversal can cause permanent damage to the amplifier and can create lock ups in systems with feedback loops.

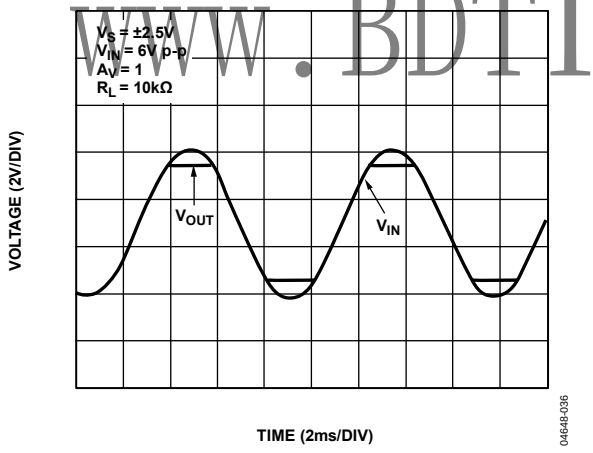

Figure 36. No Phase Reversal

DRIVING CAPACITIVE LOADS

Although the AD8615/AD8616/AD8618 are capable of driving capacitive loads of up to 500 pF without oscillating, a large amount of overshoot is present when operating at frequencies above 100 kHz. This is especially true when the amplifier is configured in positive unity gain (worst case). When such large capacitive loads are required, the use of external compensation is highly recommended.

This reduces the overshoot and minimizes ringing, which in turn improves the frequency response of the AD8615/AD8616/AD8618. One simple technique for compensation is the snubber, which consists of a simple RC network. With this circuit in place, output swing is maintained and the amplifier is stable at all gains.

Figure 38 shows the implementation of the snubber, which reduces overshoot by more than 30% and eliminates ringing that can cause instability. Using the snubber does not recover the loss of bandwidth incurred from a heavy capacitive load.

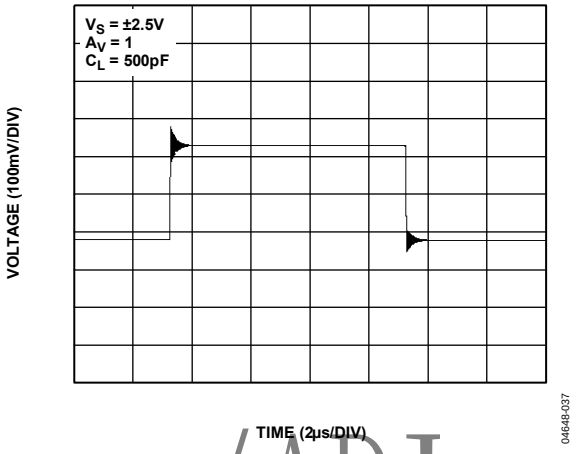

Figure 37. Driving Heavy Capacitive Loads Without Compensation

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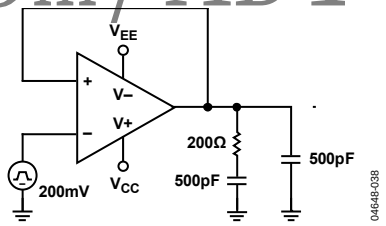

Figure 38. Snubber Network

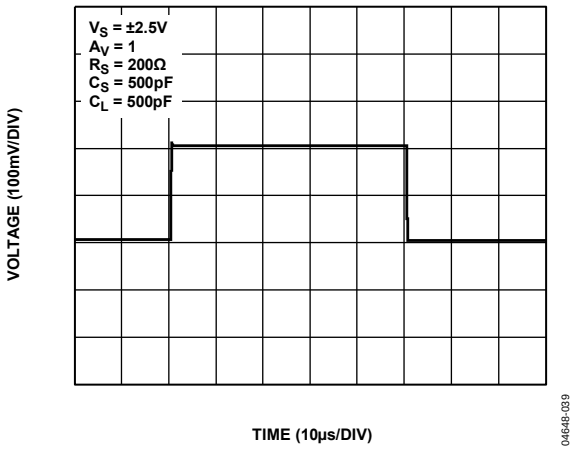

Figure 39. Driving Heavy Capacitive Loads Using the Snubber Network

OVERLOAD RECOVERY TIME

Overload recovery time is the time it takes the output of the amplifier to come out of saturation and recover to its linear region. Overload recovery is particularly important in applications where small signals must be amplified in the presence of large transients. Figure 40 and Figure 41 show the positive and negative overload recovery times of the AD8616. In both cases, the time elapsed before the AD8616 comes out of saturation is less than 1 µs. In addition, the symmetry between the positive and negative recovery times allows excellent signal rectification without distortion to the output signal.

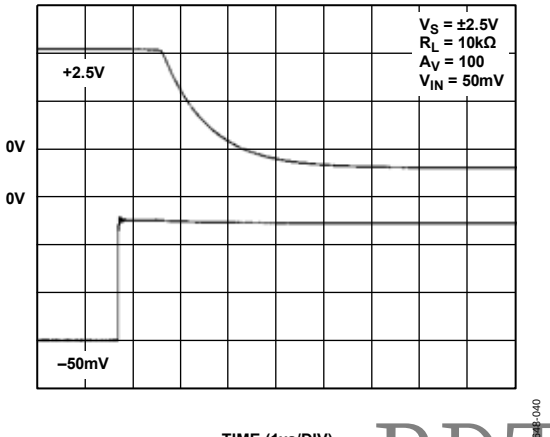

Figure 40. Positive Overload Recovery

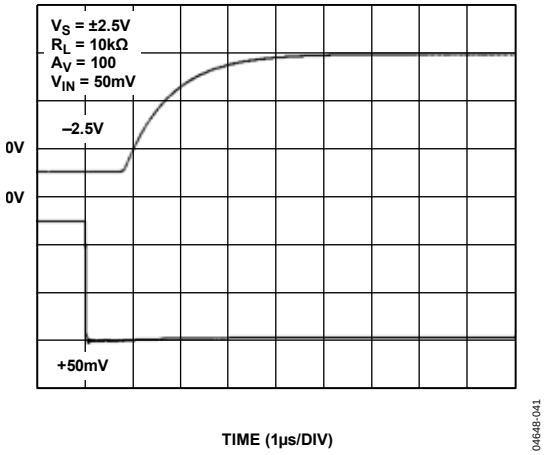

Figure 41. Negative Overload Recovery

D/A CONVERSION

The AD8616 can be used at the output of high resolution DACs. The low offset voltage, fast slew rate, and fast settling time make the part suitable to buffer voltage output or current output DACs.

Figure 42 shows an example of the AD8616 at the output of the AD5542. The AD8616's rail-to-rail output and low distortion help maintain the accuracy needed in data acquisition systems and automated test equipment.

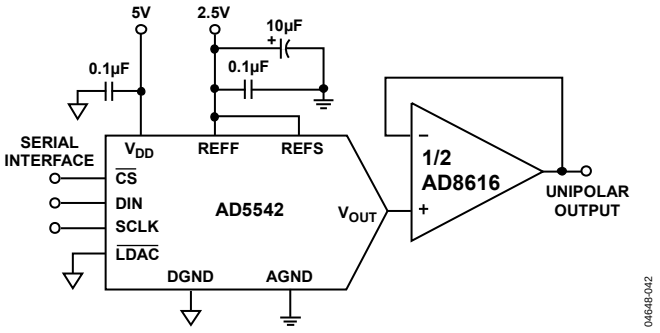

Figure 42. Buffering DAC Output

LOW NOISE APPLICATIONS

Although the AD8618 typically has less than 8 nV/√Hz of voltage noise density at 1 kHz, it is possible to reduce it further. A simple method is to connect the amplifiers in parallel, as shown in Figure 43. The total noise at the output is divided by the square root of the number of amplifiers. In this case, the total noise is approximately 4 nV/√Hz at room temperature. The 100 Ω resistor limits the current and provides an effective output resistance of 50 Ω.

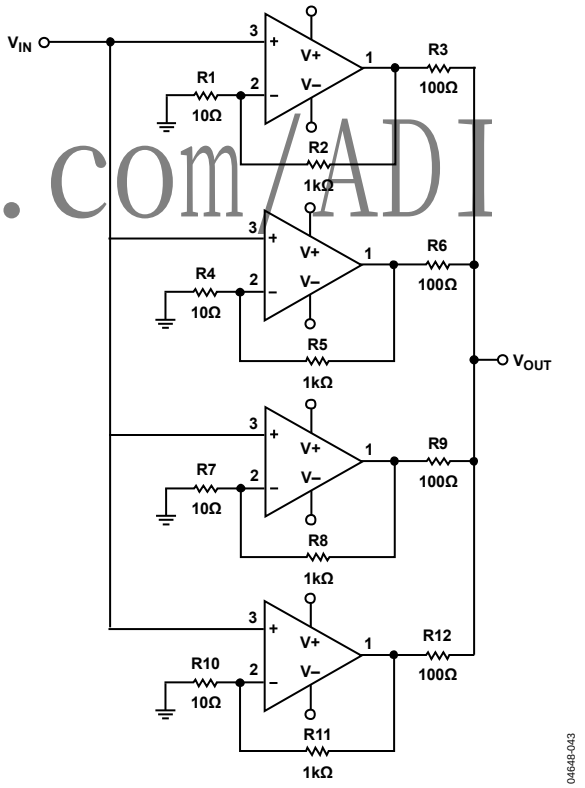

Figure 43. Noise Reduction

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HIGH SPEED PHOTODIODE PREAMPLIFIER

The AD8615/AD8616/AD8618 are excellent choices for I-to-V conversions. The very low input bias, low current noise, and high unity-gain bandwidth of the parts make them suitable, especially for high speed photodiode preamplifiers.

In high speed photodiode applications, the diode is operated in a photoconductive mode (reverse biased). This lowers the junction capacitance at the expense of an increase in the amount of dark current that flows out of the diode.

The total input capacitance, C1, is the sum of the diode and op amp input capacitances. This creates a feedback pole that causes degradation of the phase margin, making the op amp unstable. Therefore, it is necessary to use a capacitor in the feedback to compensate for this pole.

To get the maximum signal bandwidth, select

$$C2 = \sqrt{\frac{C1}{2\pi R2 f_U}}$$

where f_U is the unity-gain bandwidth of the amplifier.

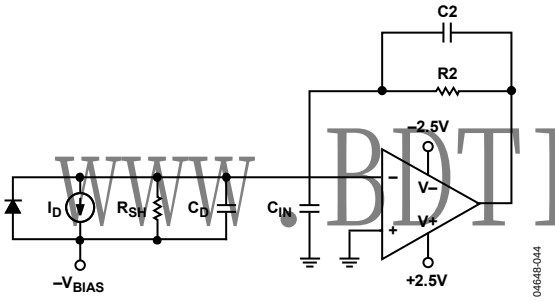

Figure 44. High Speed Photodiode Preamplifier

ACTIVE FILTERS

The low input bias current and high unity-gain bandwidth of the AD8616 make it an excellent choice for precision filter design.

Figure 45 shows the implementation of a second-order, low-pass filter. The Butterworth response has a corner frequency of 100 kHz and a phase shift of 90°. The frequency response is shown in Figure 46.

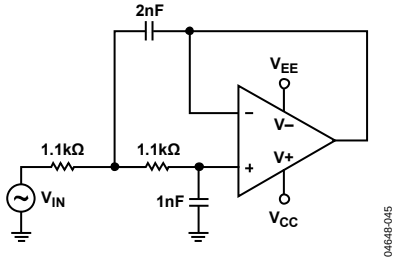

Figure 45. Second-Order, Low-Pass Filter

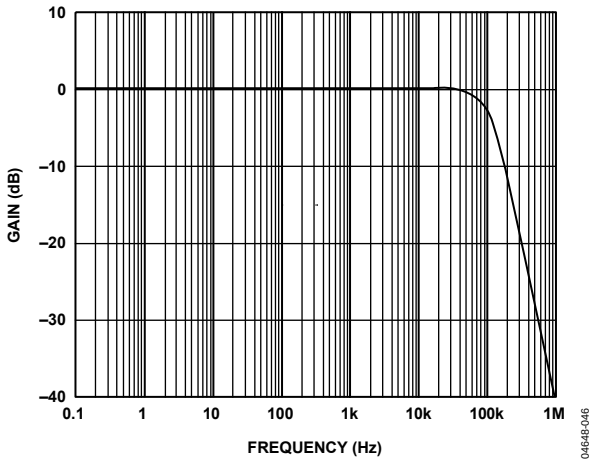

Figure 46. Second-Order Butterworth, Low-Pass Filter Frequency Response

POWER DISSIPATION

Although the AD8615/AD8616/AD8618 are capable of providing load currents up to 150 mA, the usable output, load current, and drive capability are limited to the maximum power dissipation allowed by the device package.

In any application, the absolute maximum junction temperature for the AD8615/AD8616/AD8618 is 150°C. This should never be exceeded because the device could suffer premature failure. Accurately measuring power dissipation of an integrated circuit is not always a straightforward exercise; Figure 47 is a design aid for setting a safe output current drive level or selecting a heat sink for the package options available on the AD8616.

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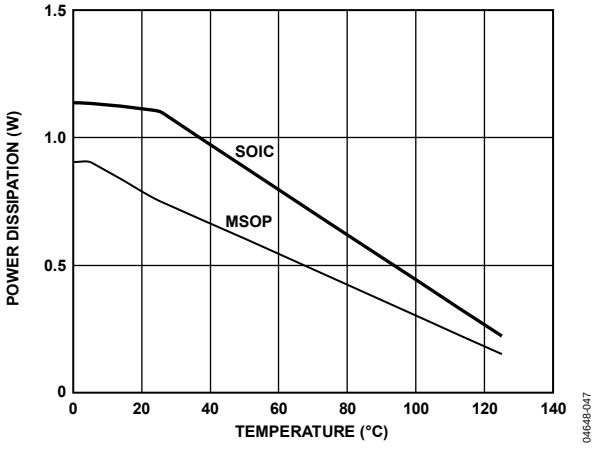

Figure 47. Maximum Power Dissipation vs. Ambient Temperature

These thermal resistance curves were determined using the AD8616 thermal resistance data for each package and a maximum junction temperature of 150°C.

The following formula can be used to calculate the internal junction temperature of the AD8615/AD8616/AD8618 for any application:

$$T_J = P_{DISS} \times \theta_{JA} + T_A$$

where:
T_J = junction temperature
P_{DISS} = power dissipation
θ_{JA} = package thermal resistance, junction-to-case
T_A = ambient temperature of the circuit

To calculate the power dissipated by the AD8615/AD8616/AD8618, use the following:

$$P_{DISS} = I_{LOAD} \times (V_S - V_{OUT})$$

where:
I_{LOAD} = output load current
V_S = supply voltage
V_{OUT} = output voltage

The quantity within the parentheses is the maximum voltage developed across either output transistor.

POWER CALCULATIONS FOR VARYING OR UNKNOWN LOADS

Often, calculating power dissipated by an integrated circuit to determine if the device is being operated in a safe range is not as simple as it may seem. In many cases, power cannot be directly measured. This may be the result of irregular output waveforms or varying loads. Indirect methods of measuring power are required.

There are two methods to calculate power dissipated by an integrated circuit. The first is to measure the package temperature and the board temperature. The second is to directly measure the circuit's supply current.

Calculating Power by Measuring Ambient Temperature and Case Temperature

The two equations for calculating the junction temperature are

$$T_J = T_A + P\,\theta_{JA}$$

where:
T_J = junction temperature
T_A = ambient temperature
θ_{JA} = the junction-to-ambient thermal resistance

$$T_J = T_C + P\,\theta_{JC}$$

where:
T_C is case temperature.
θ_{JA} and θ_{JC} are given in the data sheet.

The two equations for calculating P (power) are

$$T_A + P\,\theta_{JA} = T_C + P\,\theta_{JC}$$

$$P = (T_A - T_C)/(\theta_{JC} - \theta_{JA})$$

Once the power is determined, it is necessary to recalculate the junction temperature to ensure that the temperature was not exceeded.

The temperature should be measured directly on and near the package but not touching it. Measuring the package can be difficult. A very small bimetallic junction glued to the package can be used, or an infrared sensing device can be used, if the spot size is small enough.

Calculating Power by Measuring Supply Current

If the supply voltage and current are known, power can be calculated directly. However, the supply current can have a dc component with a pulse directed into a capacitive load, which can make the rms current very difficult to calculate. This difficulty can be overcome by lifting the supply pin and inserting an rms current meter into the circuit. For this method to work, make sure the current is delivered by the supply pin being measured. This is usually a good method in a single-supply system; however, if the system uses dual supplies, both supplies may need to be monitored.

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OUTLINE DIMENSIONS

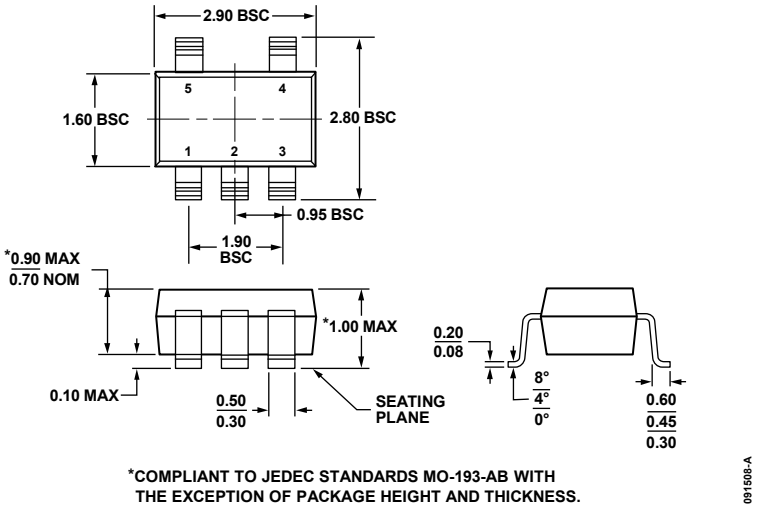

Figure 48. 5-Lead Thin Small Outline Transistor Package [TSOT] (UJ-5)
Dimensions shown in millimeters

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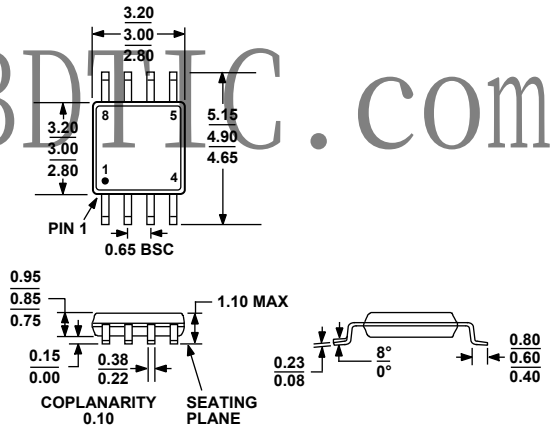
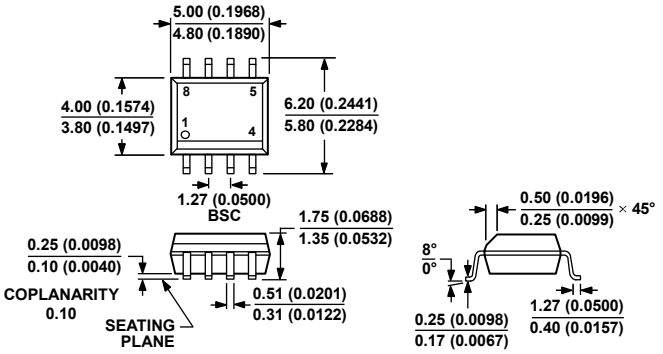


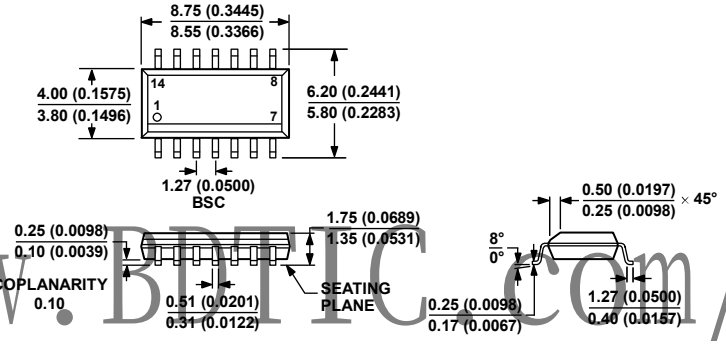
Figure 49. 8-Lead Mini Small Outline Package [MSOP] (RM-8)
Dimensions shown in millimeters



COMPLIANT TO JEDEC STANDARDS MS-012-AA
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS
(IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

012407-A

Figure 50. 8-Lead Standard Small Outline Package [SOIC_N]
Narrow Body (R-8)
Dimensions shown in millimeters and (inches)



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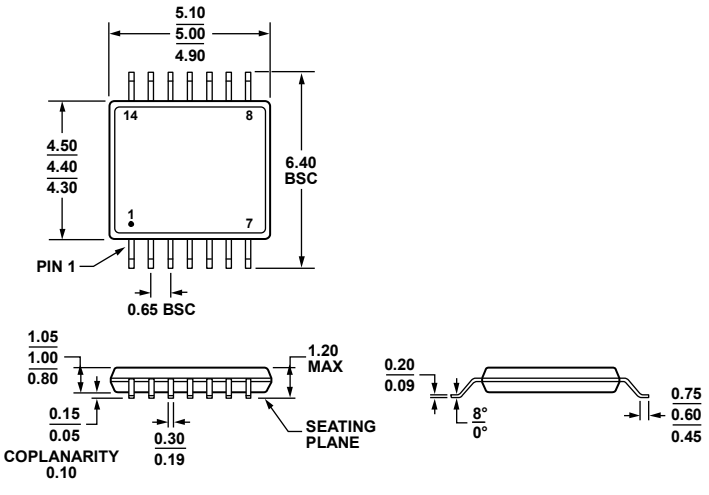
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

060606-A

Figure 51. 14-Lead Standard Small Outline Package [SOIC_N]
Narrow Body (R-14)
Dimensions shown in millimeters and (inches)



COMPLIANT TO JEDEC STANDARDS MO-153-AB-1

061908-A

Figure 52. 14-Lead Thin Shrink Small Outline Package [TSSOP]
(RU-14)
Dimensions shown in millimeters

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option	Branding
AD8615AUJZ-R2[1]	–40°C to +125°C	5-Lead TSOT-23	UJ-5	BKA
AD8615AUJZ-REEL[1]	–40°C to +125°C	5-Lead TSOT-23	UJ-5	BKA
AD8615AUJZ-REEL7[1]	–40°C to +125°C	5-Lead TSOT-23	UJ-5	BKA
AD8616ARM-R2	–40°C to +125°C	8-Lead MSOP	RM-8	BLA
AD8616ARM-REEL	–40°C to +125°C	8-Lead MSOP	RM-8	BLA
AD8616ARMZ[1]	–40°C to +125°C	8-Lead MSOP	RM-8	A0K
AD8616ARMZ-R2[1]	–40°C to +125°C	8-Lead MSOP	RM-8	A0K
AD8616ARMZ-REEL[1]	–40°C to +125°C	8-Lead MSOP	RM-8	A0K
AD8616AR	–40°C to +125°C	8-Lead SOIC_N	R-8	
AD8616AR-REEL	–40°C to +125°C	8-Lead SOIC_N	R-8	
AD8616AR-REEL7	–40°C to +125°C	8-Lead SOIC_N	R-8	
AD8616ARZ[1]	–40°C to +125°C	8-Lead SOIC_N	R-8	
AD8616ARZ-REEL[1]	–40°C to +125°C	8-Lead SOIC_N	R-8	
AD8616ARZ-REEL7[1]	–40°C to +125°C	8-Lead SOIC_N	R-8	
AD8618AR	–40°C to +125°C	14-Lead SOIC_N	R-14	
AD8618AR-REEL	–40°C to +125°C	14-Lead SOIC_N	R-14	
AD8618AR-REEL7	–40°C to +125°C	14-Lead SOIC_N	R-14	
AD8618ARZ[1]	–40°C to +125°C	14-Lead SOIC_N	R-14	
AD8618ARZ-REEL[1]	–40°C to +125°C	14-Lead SOIC_N	R-14	
AD8618ARZ-REEL7[1]	–40°C to +125°C	14-Lead SOIC_N	R-14	
AD8618ARU	–40°C to +125°C	14-Lead TSSOP	RU-14	
AD8618ARU-REEL	–40°C to +125°C	14-Lead TSSOP	RU-14	
AD8618ARUZ[1]	–40°C to +125°C	14-Lead TSSOP	RU-14	
AD8618ARUZ-REEL[1]	–40°C to +125°C	14-Lead TSSOP	RU-14	

[1] Z = RoHS Compliant Part.

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